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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	16KB (8K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 24x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f24k40-e-ss

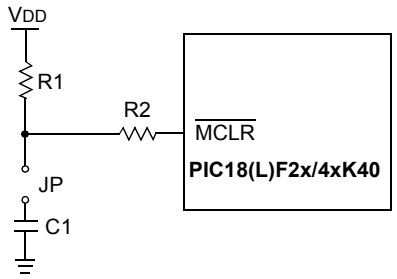
2.3 Master Clear (MCLR) Pin

The MCLR pin provides two specific device functions: Device Reset, and Device Programming and Debugging. If programming and debugging are not required in the end application, a direct connection to VDD may be all that is required. The addition of other components, to help increase the application's resistance to spurious Resets from voltage sags, may be beneficial. A typical configuration is shown in Figure 2-1. Other circuit designs may be implemented, depending on the application's requirements.

During programming and debugging, the resistance and capacitance that can be added to the pin must be considered. Device programmers and debuggers drive the MCLR pin. Consequently, specific voltage levels (VIH and VIL) and fast signal transitions must not be adversely affected. Therefore, specific values of R1 and C1 will need to be adjusted based on the application and PCB requirements. For example, it is recommended that the capacitor, C1, be isolated from the MCLR pin during programming and debugging operations by using a jumper (Figure 2-2). The jumper is replaced for normal run-time operations.

Any components associated with the MCLR pin should be placed within 0.25 inch (6 mm) of the pin.

FIGURE 2-2: EXAMPLE OF MCLR PIN CONNECTIONS



Note 1: R1 ≤ 10 kΩ is recommended. A suggested starting value is 10 kΩ. Ensure that the MCLR pin VIH and VIL specifications are met.

2: R2 ≤ 470Ω will limit any current flowing into MCLR from the external capacitor, C1, in the event of MCLR pin breakdown, due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS). Ensure that the MCLR pin VIH and VIL specifications are met.

2.4 ICSP™ Pins

The PGC and PGD pins are used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of ohms, not to exceed 100Ω.

Pull-up resistors, series diodes and capacitors on the PGC and PGD pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits, and pin input voltage high (VIH) and input low (VIL) requirements.

For device emulation, ensure that the "Communication Channel Select" (i.e., PGCx/PGDx pins), programmed into the device, matches the physical connections for the ICSP to the Microchip debugger/emulator tool.

For more information on available Microchip development tools connection requirements, refer to **Section 36.0 "Development Support"**.

REGISTER 3-13: REVISION ID: REVISION ID REGISTER

R	R	R	R	R	R	R	R
1	0	1	0	MJRREV<5:2>			
bit 15							bit 8

R	R	R	R	R	R	R	R
MJRREV<1:0>		MNRREV<5:0>					
bit 7							bit 0

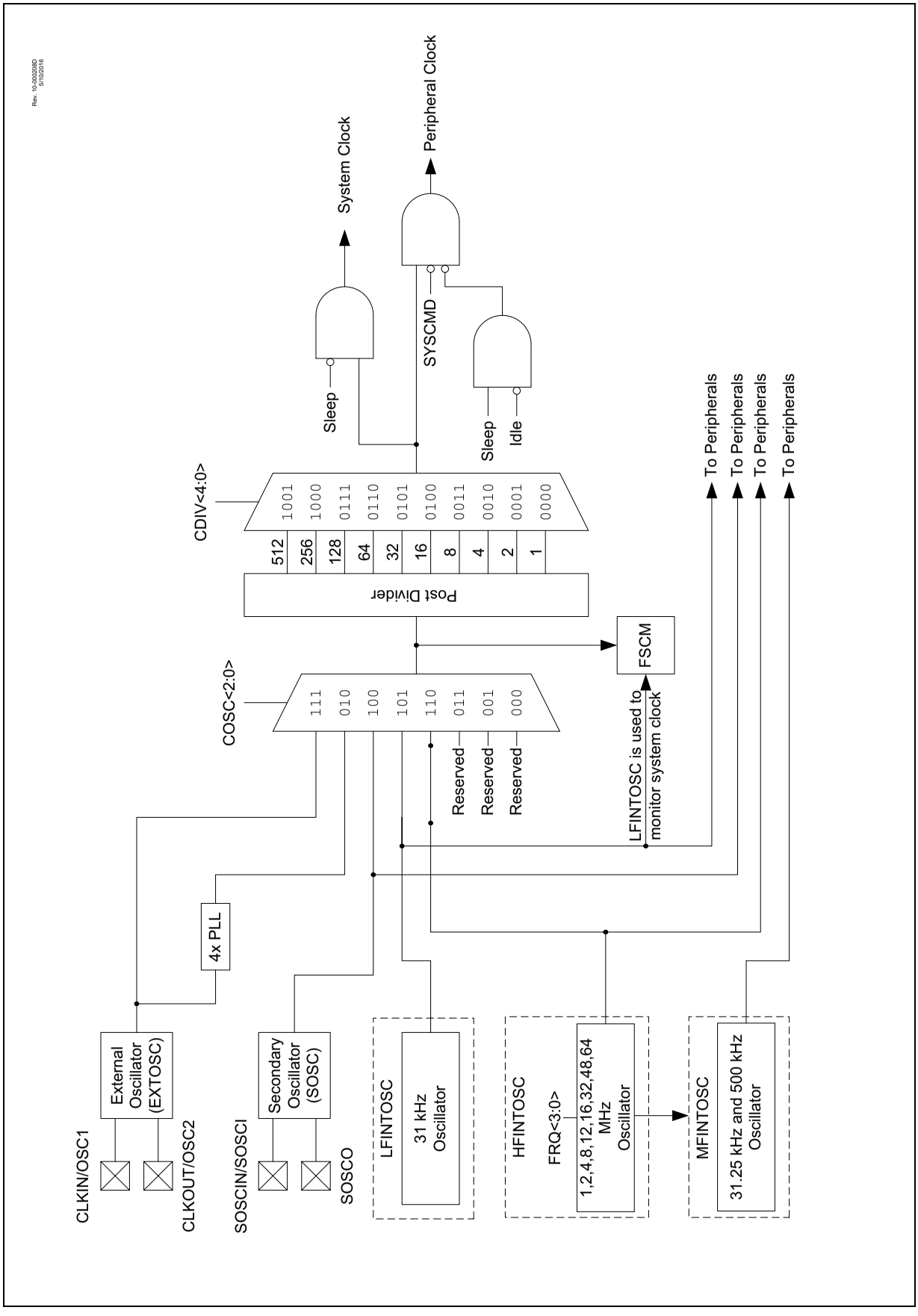
Legend:			
R = Readable bit	'1' = Bit is set	0' = Bit is cleared	x = Bit is unknown

bit 15-12 **Read as '1010'**
These bits are fixed with value '1010' for all devices in this family.

bit 11-6 **MJRREV<5:0>:** Major Revision ID bits
These bits are used to identify a major revision. A major revision is indicated by an all-layer revision (A0, B0, C0, etc.).
Revision A = 6'b00_0000

bit 5-0 **MNRREV<5:0>:** Minor Revision ID bits
These bits are used to identify a minor revision.

FIGURE 4-1: SIMPLIFIED PIC® MCU CLOCK SOURCE BLOCK DIAGRAM



9.2 Independent Clock Source

The WWDT can derive its time base from either the 31 kHz LFINTOSC or 31.25 kHz MFINTOSC internal oscillators, depending on the value of WDTE<1:0> Configuration bits.

If WDTE = 2'b1x, then the clock source will be enabled depending on the WDTCCS<2:0> Configuration bits.

If WDTE = 2'b01, the SEN bit should be set by software to enable WWDT, and the clock source is enabled by the WDTCS bits in the WDTCON1 register.

Time intervals in this chapter are based on a minimum nominal interval of 1 ms. See **Section 37.0 "Electrical Specifications"** for LFINTOSC and MFINTOSC tolerances.

9.3 WWDT Operating Modes

The Windowed Watchdog Timer module has four operating modes controlled by the WDTE<1:0> bits in Configuration Words. See Table 9-1.

9.3.1 WWDT IS ALWAYS ON

When the WDTE bits of Configuration Words are set to '11', the WWDT is always on.

WWDT protection is active during Sleep.

9.3.2 WWDT IS OFF IN SLEEP

When the WDTE bits of Configuration Words are set to '10', the WWDT is on, except in Sleep.

WWDT protection is not active during Sleep.

9.3.3 WWDT CONTROLLED BY SOFTWARE

When the WDTE bits of Configuration Words are set to '01', the WWDT is controlled by the SEN bit of the WDTCON0 register.

WWDT protection is unchanged by Sleep. See Table 9-1 for more details.

TABLE 9-1: WWDT OPERATING MODES

WDTE<1:0>	SEN	Device Mode	WWDT Mode
11	X	X	Active
10	X	Awake	Active
		Sleep	Disabled
01	1	X	Active
	0	X	Disabled
00	X	X	Disabled

9.4 Time-out Period

If the WDTCPS<4:0> Configuration bits default to 5'b11111, then the WDTPS bits of the WDTCON0 register set the time-out period from 1 ms to 256 seconds (nominal). If any value other than the default value is assigned to WDTCPS<4:0> Configuration bits, then the timer period will be based on the WDTCPS<4:0> bits in the CONFIG3L register. After a Reset, the default time-out period is 2s.

9.5 Watchdog Window

The Windowed Watchdog Timer has an optional Windowed mode that is controlled by the WDTCWS<2:0> Configuration bits and WINDOW<2:0> bits of the WDTCON1 register. In the Windowed mode, the CLRWDT instruction must occur within the allowed window of the WDT period. Any CLRWDT instruction that occurs outside of this window will trigger a window violation and will cause a WWDT Reset, similar to a WWDT time out. See Figure 9-2 for an example.

The window size is controlled by the WINDOW<2:0> Configuration bits, or the WINDOW<2:0> bits of WDTCON1, if WDTCWS<2:0> = 111.

The five Most Significant bits of the WDTTMR register are used to determine whether the window is open, as defined by the WINDOW<2:0> bits of the WDTCON1 register.

In the event of a window violation, a Reset will be generated and the $\overline{\text{WDTWV}}$ bit of the PCON0 register will be cleared. This bit is set by a POR or can be set in firmware.

9.6 Clearing the WWDT

The WWDT is cleared when any of the following conditions occur:

- Any Reset
- Valid CLRWDT instruction is executed
- Device enters Sleep
- Exit Sleep by Interrupt
- WWDT is disabled
- Oscillator Start-up Timer (OST) is running
- Any write to the WDTCON0 or WDTCON1 registers

9.6.1 CLRWDT CONSIDERATIONS (WINDOWED MODE)

When in Windowed mode, the WWDT must be armed before a CLRWDT instruction will clear the timer. This is performed by reading the WDTCON0 register. Executing a CLRWDT instruction without performing such an arming action will trigger a window violation regardless of whether the window is open or not.

See Table 9-2 for more information.

10.1.1 PROGRAM COUNTER

The Program Counter (PC) specifies the address of the instruction to fetch for execution. The PC is 21 bits wide and is contained in three separate 8-bit registers. The low byte, known as the PCL register, is both readable and writable. The high byte, or PCH register, contains the PC<15:8> bits; it is not directly readable or writable. Updates to the PCH register are performed through the PCLATH register. The upper byte is called PCU. This register contains the PC<20:16> bits; it is also not directly readable or writable. Updates to the PCU register are performed through the PCLATU register.

The contents of PCLATH and PCLATU are transferred to the program counter by any operation that writes PCL. Similarly, the upper two bytes of the program counter are transferred to PCLATH and PCLATU by an operation that reads PCL. This is useful for computed offsets to the PC (see **Section 10.2.3.1 "Computed GOTO"**).

The PC addresses bytes in the program memory. To prevent the PC from becoming misaligned with word instructions, the Least Significant bit of PCL is fixed to a value of '0'. The PC increments by two to address sequential instructions in the program memory.

The CALL, RCALL, GOTO and program branch instructions write to the program counter directly. For these instructions, the contents of PCLATH and PCLATU are not transferred to the program counter.

10.1.2 RETURN ADDRESS STACK

The return address stack allows any combination of up to 31 program calls and interrupts to occur. The PC is pushed onto the stack when a CALL or RCALL instruction is executed or an interrupt is Acknowledged. The PC value is pulled off the stack on a RETURN, RETLW or a RETFIE instruction. PCLATU and PCLATH are not affected by any of the RETURN or CALL instructions.

The stack operates as a 31-word by 21-bit RAM and a 5-bit Stack Pointer, or as a 35-word by 21-bit RAM with a 6-bit Stack Pointer in ICD mode. The stack space is not part of either program or data space. The Stack Pointer is readable and writable and the address on the top of the stack is readable and writable through the Top-of-Stack (TOS) Special File registers. Data can also be pushed to, or popped from the stack, using these registers.

A CALL type instruction causes a push onto the stack; the Stack Pointer is first incremented and the location pointed to by the Stack Pointer is written with the contents of the PC (already pointing to the instruction following the CALL). A RETURN type instruction causes a pop from the stack; the contents of the location pointed to by the STKPTR are transferred to the PC and then the Stack Pointer is decremented.

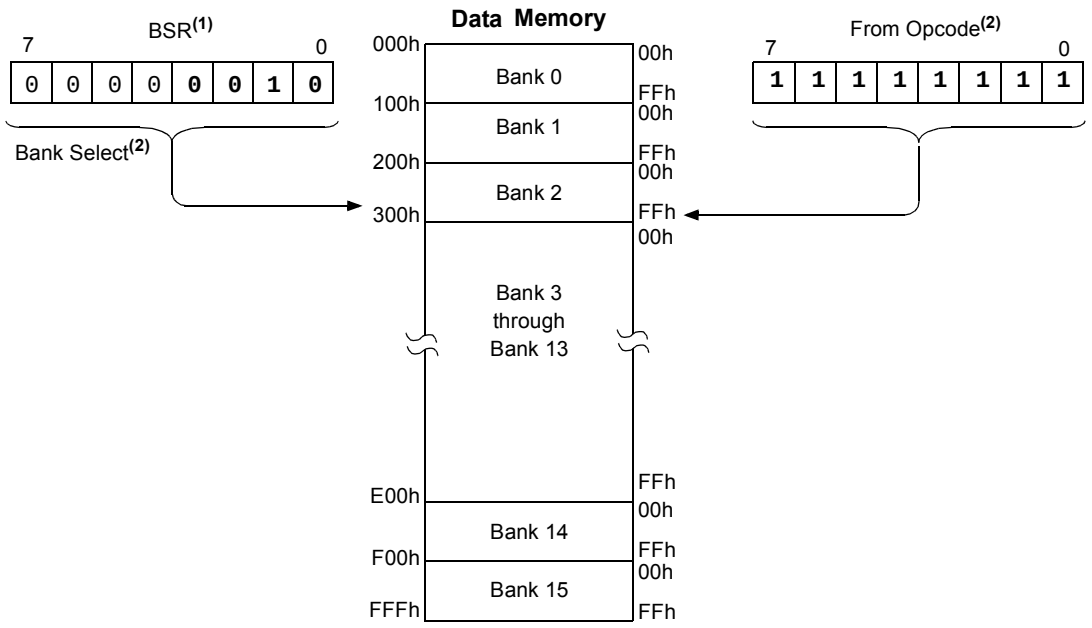
The Stack Pointer is initialized to '00000' after all Resets. There is no RAM associated with the location corresponding to a Stack Pointer value of '00000'; this is only a Reset value. Status bits in the PCON0 register indicate if the stack is full or has overflowed or has underflowed.

10.1.2.1 Top-of-Stack Access

Only the top of the return address stack (TOS) is readable and writable. A set of three registers, TOSU:TOSH:TOSL, hold the contents of the stack location pointed to by the STKPTR register (Figure 10-1). This allows users to implement a software stack if necessary. After a CALL, RCALL or interrupt, the software can read the pushed value by reading the TOSU:TOSH:TOSL registers. These values can be placed on a user defined software stack. At return time, the software can return these values to TOSU:TOSH:TOSL and do a return.

The user must disable the Global Interrupt Enable (GIE) bits while accessing the stack to prevent inadvertent stack corruption.

FIGURE 10-5: USE OF THE BANK SELECT REGISTER (DIRECT ADDRESSING)



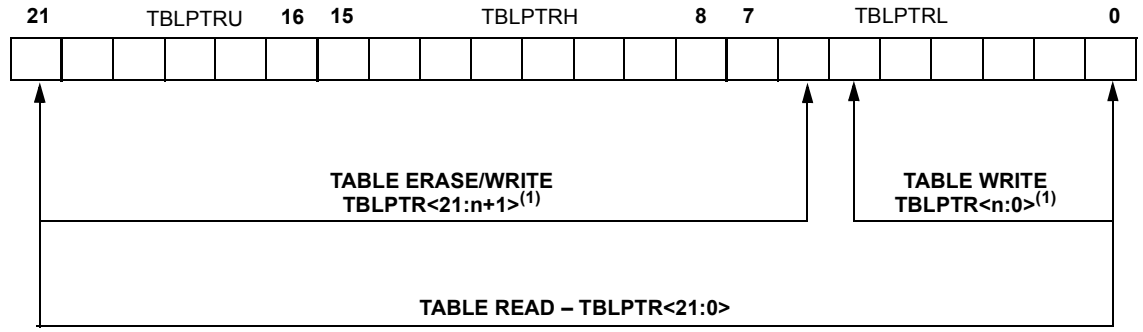
Note 1: The Access RAM bit of the instruction can be used to force an override of the selected bank (BSR<3:0>) to the registers of the Access Bank.

2: The `MOVFF` instruction embeds the entire 12-bit address in the instruction.

TABLE 11-3: TABLE POINTER OPERATIONS WITH TBLRD AND TBLWT INSTRUCTIONS

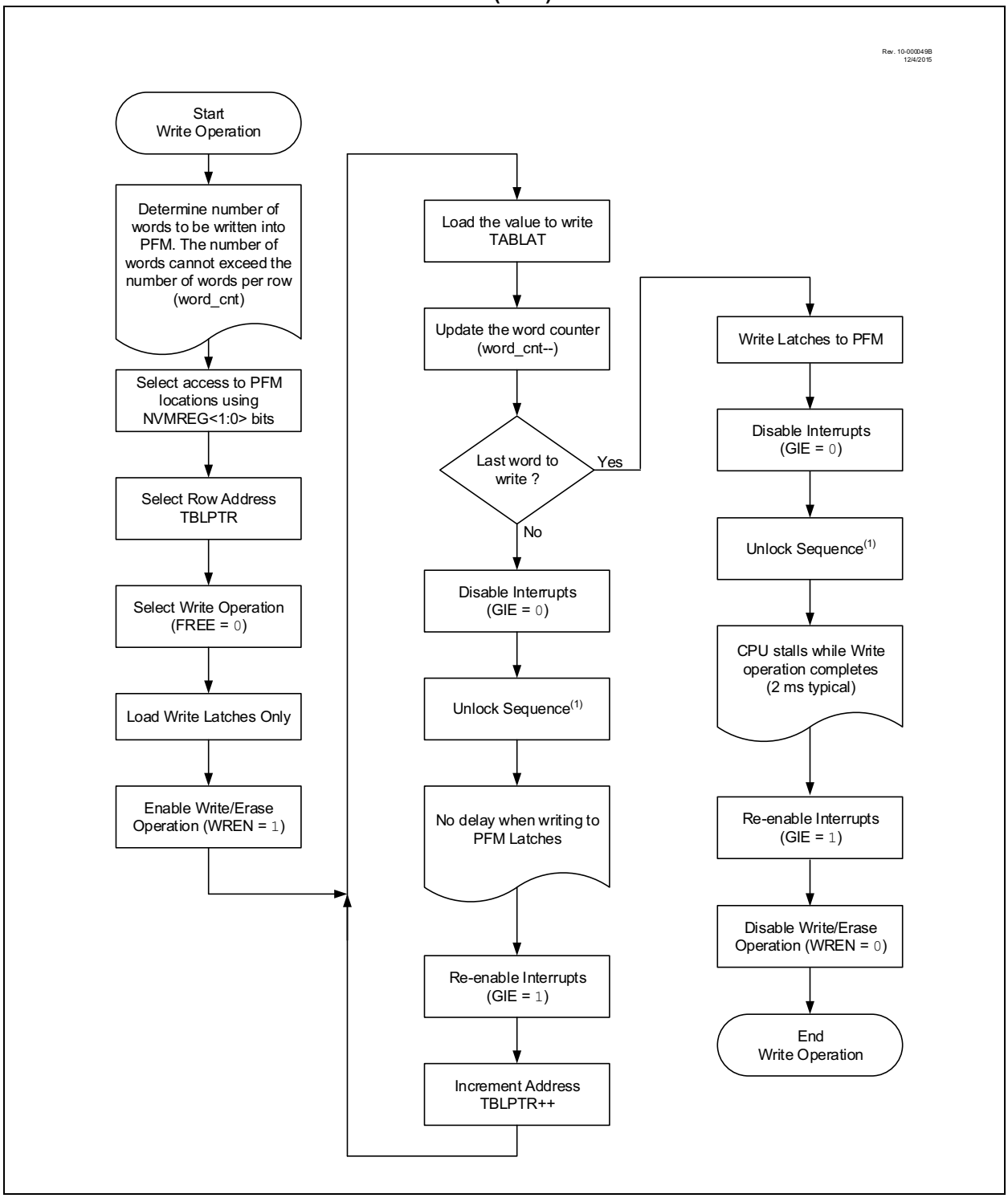
Example	Operation on Table Pointer
TBLRD* TBLWT*	TBLPTR is not modified
TBLRD*+ TBLWT*+	TBLPTR is incremented after the read/write
TBLRD*- TBLWT*-	TBLPTR is decremented after the read/write
TBLRD+* TBLWT+*	TBLPTR is incremented before the read/write

FIGURE 11-3: TABLE POINTER BOUNDARIES BASED ON OPERATION



Note 1: Refer to Table 11-3 for the row size values.

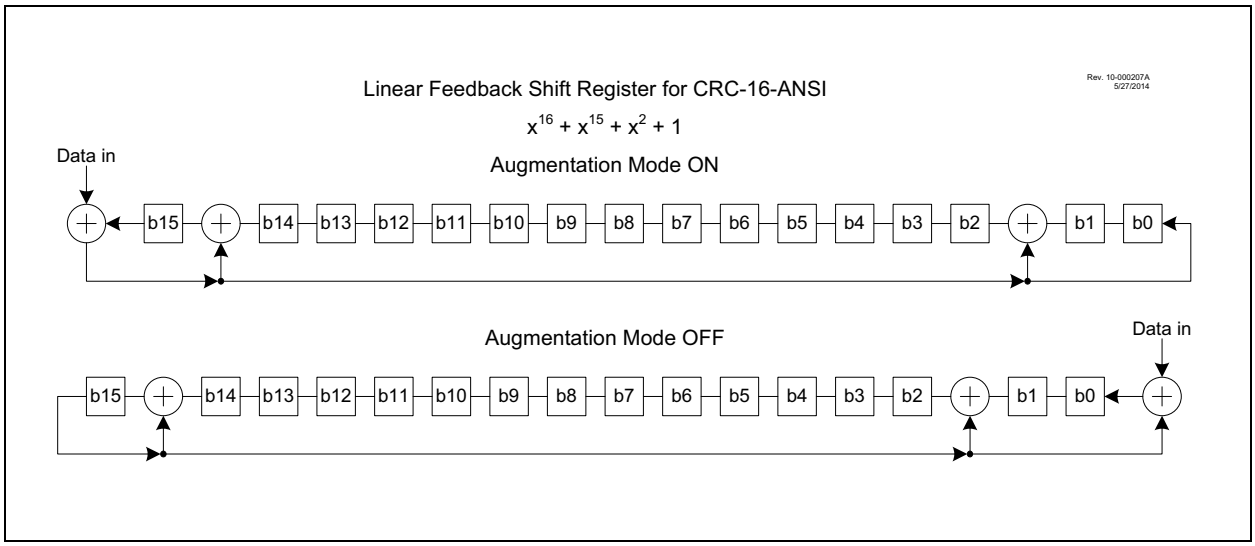
FIGURE 11-9: PROGRAM FLASH MEMORY (PFM) WRITE FLOWCHART



13.4 CRC Polynomial Implementation

Any polynomial can be used. The polynomial and accumulator sizes are determined by the PLEN<3:0> bits. For an n-bit accumulator, PLEN = n-1 and the corresponding polynomial is n+1 bits. Therefore, the accumulator can be any size up to 16 bits with a corresponding polynomial up to 17 bits. The MSb and LSb of the polynomial are always '1' which is forced by hardware. All polynomial bits between the MSb and LSb are specified by the CRCXOR registers. For example, when using CRC16-ANSI, the polynomial is defined as $X^{16}+X^{15}+X^2+1$. The X^{16} and X^0 = 1 terms are the MSb and LSb controlled by hardware. The X^{15} and X^2 terms are specified by setting the corresponding CRCXOR<15:0> bits with the value of 0x8004. The actual value is 0x8005 because the hardware sets the LSb to 1. However, the LSb of the CRCXORL register is unimplemented and always reads as '0'. Refer to Example 13-1.

EXAMPLE 13-2: CRC LFSR EXAMPLE



13.5 CRC Data Sources

Data can be input to the CRC module in two ways:

- User data using the CRCDATA registers (CRCDATH and CRCDATL)
- Flash using the Program Memory Scanner

To set the number of bits of data, up to 16 bits, the DLEN bits of CRCCON1 must be set accordingly. Only data bits in CRCDATA registers up to DLEN will be used, other data bits in CRCDATA registers will be ignored.

Data is moved into the CRCSHIFT as an intermediate to calculate the check value located in the CRCACC registers.

The SHIFTM bit is used to determine the bit order of the data being shifted into the accumulator. If SHIFTM is not set, the data will be shifted in MSb first (Big Endian). The value of DLEN will determine the MSb. If SHIFTM bit is set, the data will be shifted into the accumulator in reversed order, LSb first (Little Endian).

The CRC module can be seeded with an initial value by setting the CRCACC<15:0> registers to the appropriate value before beginning the CRC.

13.5.1 CRC FROM USER DATA

To use the CRC module on data input from the user, the user must write the data to the CRCDAT registers. The data from the CRCDAT registers will be latched into the shift registers on any write to the CRCDATL register.

13.5.2 CRC FROM FLASH

To use the CRC module on data located in Flash memory, the user can initialize the Program Memory Scanner as defined in **Section 13.9, Program Memory Scan Configuration**.

REGISTER 14-18: IPR0: PERIPHERAL INTERRUPT PRIORITY REGISTER 0

U-0	U-0	R/W-1/1	R/W-1/1	U-0	R/W-1/1	R/W-1/1	R/W-1/1
—	—	TMR0IP	IOCIP	—	INT2IP	INT1IP	INT0IP
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **Unimplemented:** Read as '0'

bit 5 **TMR0IP:** Timer0 Interrupt Priority bit
1 = High priority
0 = Low priority

bit 4 **IOCIP:** Interrupt-on-Change Priority bit
1 = High priority
0 = Low priority

bit 3 **Unimplemented:** Read as '0'

bit 2 **INT2IP:** External Interrupt 2 Priority bit
1 = High priority
0 = Low priority

bit 1 **INT1IP:** External Interrupt 1 Priority bit
1 = High priority
0 = Low priority

bit 0 **INT0IP:** External Interrupt 0 Priority bit
1 = High priority
0 = Low priority

TABLE 14-1: SUMMARY OF REGISTERS ASSOCIATED WITH INTERRUPTS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE/GIEH	PEIE/GIEL	IPEN	—	—	INT2EDG	INT1EDG	INT0EDG	166
PIE0	—	—	TMR0IE	IOCIE	—	INT2IE	INT1IE	INT0IE	175
PIE1	OSCFIE	CSWIE	—	—	—	—	ADTIE	ADIE	176
PIE2	HLVDIE	ZCDIE	—	—	—	—	C2IE	C1IE	177
PIE3	—	—	RC1IE	TX1IE	—	—	BCL1IE	SSP1IE	178
PIE4	—	—	TMR6IE	TMR5IE	TMR4IE	TMR3IE	TMR2IE	TMR1IE	179
PIE5	—	—	—	—	—	TMR5GIE	TMR3GIE	TMR1GIE	180
PIE6	—	—	—	—	—	—	CCP2IE	CCP1IE	181
PIE7	SCANIE	CRCIE	NVMIE	—	—	—	—	CWG1IE	182
PIR0	—	—	TMR0IF	IOCIF	—	INT2IF	INT1IF	INT0IF	167
PIR1	OSCFIF	CSWIF	—	—	—	—	ADTIF	ADIF	168
PIR2	HLVDIF	ZCDIF	—	—	—	—	C2IF	C1IF	169
PIR3	—	—	RC1IF	TX1IF	—	—	BCL1IF	SSP1IF	170
PIR4	—	—	TMR6IF	TMR5IF	TMR4IF	TMR3IF	TMR2IF	TMR1IF	171
PIR5	—	—	—	—	—	TMR5GIF	TMR3GIF	TMR1GIF	172
PIR6	—	—	—	—	—	—	CCP2IF	CCP1IF	173
PIR7	SCANIF	CRCIF	NVMIF	—	—	—	—	CWG1IF	174
IPR0	—	—	TMR0IP	IOCIP	—	INT2IP	INT1IP	INT0IP	183
IPR1	OSCFIP	CSWIP	—	—	—	—	ADTIP	ADIP	184
IPR2	HLVDIP	ZCDIP	—	—	—	—	C2IP	C1IP	185
IPR3	—	—	RC1IP	TX1IP	—	—	BCL1IP	SSP1IP	186
IPR4	—	—	TMR6IP	TMR5IP	TMR4IP	TMR3IP	TMR2IP	TMR1IP	187
IPR5	—	—	—	—	—	TMR5GIP	TMR3GIP	TMR1GIP	188
IPR6	—	—	—	—	—	—	CCP2IP	CCP1IP	189
IPR7	SCANIP	CRCIP	NVMIP	—	—	—	—	CWG1IP	190

Legend: — = unimplemented locations, read as '0'. Shaded bits are not used for Interrupts.

REGISTER 15-6: ODCONx: OPEN-DRAIN CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ODCx7	ODCx6	ODCx5	ODCx4	ODCx3	ODCx2	ODCx1	ODCx0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown
-n/n = Value at POR and BOR/Value at all other Resets		

bit 7-0 **ODCx<7:0>**: Open-Drain Configuration on Pins Rx<7:0>

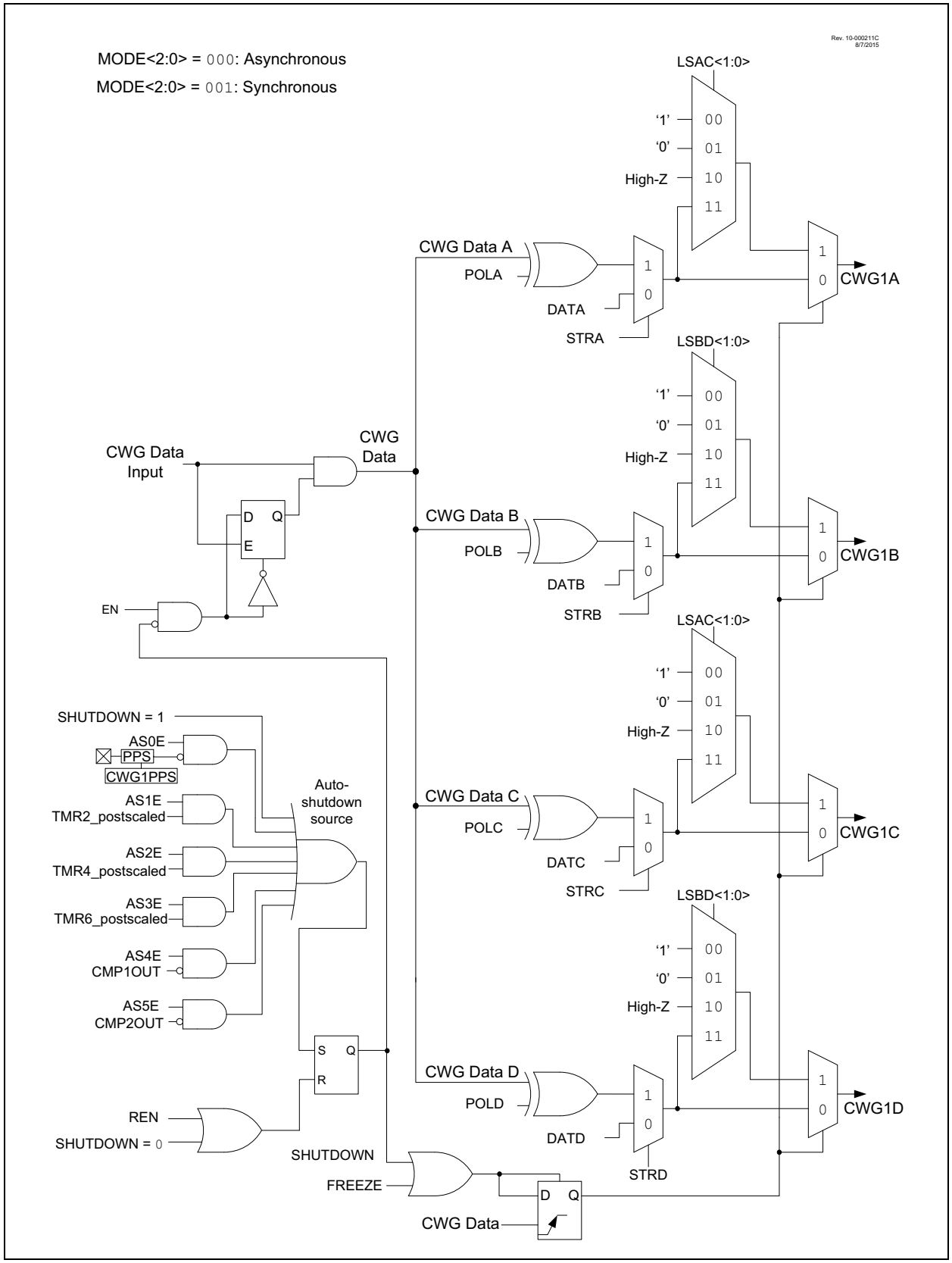
1 = Output drives only low-going signals (sink current only)

0 = Output drives both high-going and low-going signals (source and sink current)

TABLE 15-7: OPEN-DRAIN CONTROL REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ODCONA	ODCA7	ODCA6	ODCA5	ODCA4	ODCA3	ODCA2	ODCA1	ODCA0
ODCONB	ODCB7	ODCB6	ODCB5	ODCB4	ODCB3	ODCB2	ODCB1	ODCB0
ODCONC	ODCC7	ODCC6	ODCC5	ODCC4	ODCC3	ODCC2	ODCC1	ODCC0

FIGURE 24-11: SIMPLIFIED CWG BLOCK DIAGRAM (OUTPUT STEERING MODES)



REGISTER 24-2: CWG1CON1: CWG CONTROL REGISTER 1

U-0	U-0	R-x	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	IN	—	POLD	POLC	POLB	POLA
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5 **IN:** CWG Input Value bit (read-only)

bit 4 **Unimplemented:** Read as ‘0’

bit 3 **POLD:** CWG1D Output Polarity bit
1 = Signal output is inverted polarity
0 = Signal output is normal polarity

bit 2 **POLC:** CWG1C Output Polarity bit
1 = Signal output is inverted polarity
0 = Signal output is normal polarity

bit 1 **POLB:** CWG1B Output Polarity bit
1 = Signal output is inverted polarity
0 = Signal output is normal polarity

bit 0 **POLA:** CWG1A Output Polarity bit
1 = Signal output is inverted polarity
0 = Signal output is normal polarity

FIGURE 26-14: I²C SLAVE, 7-BIT ADDRESS, RECEPTION (SEN = 0, AHEN = 0, DHEN = 0)

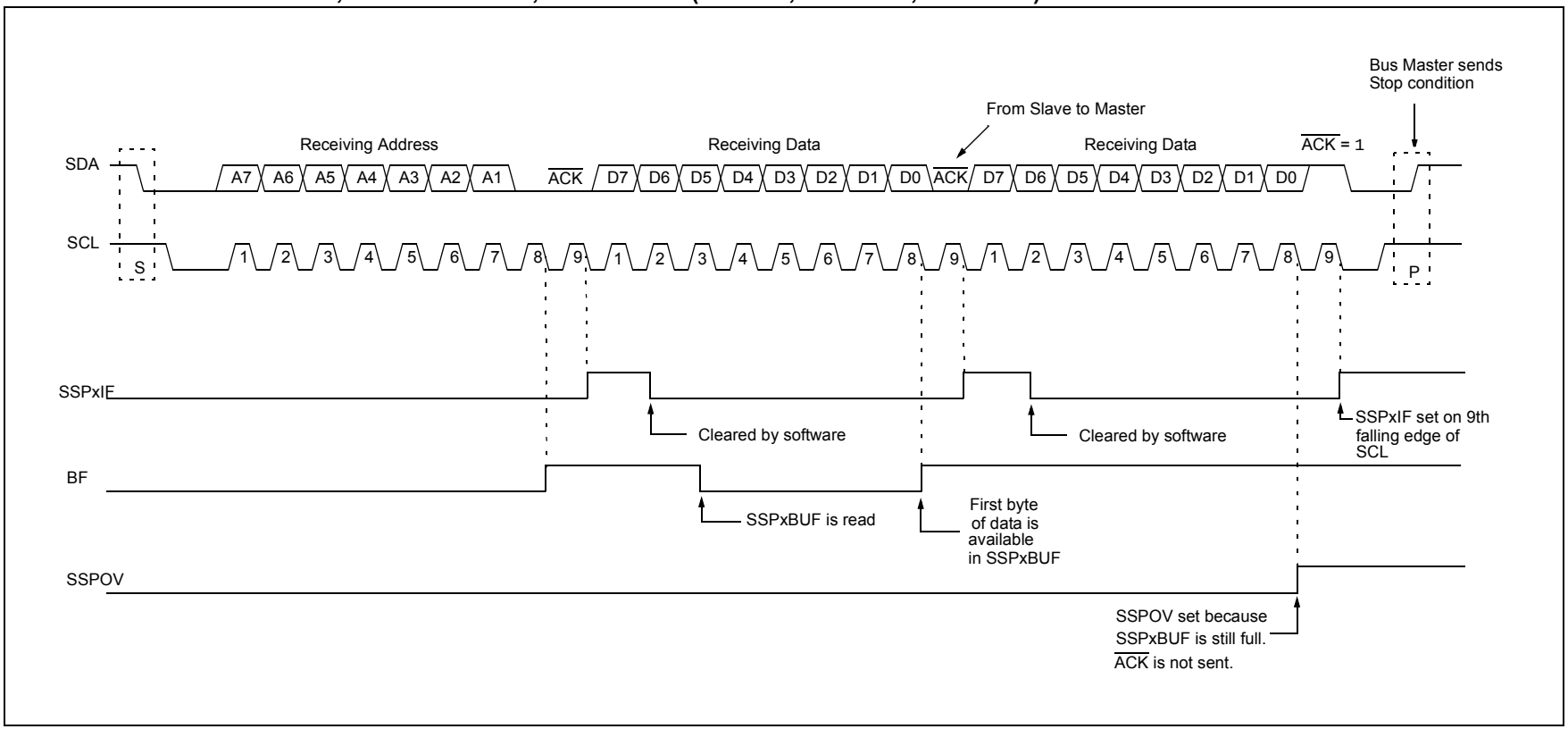
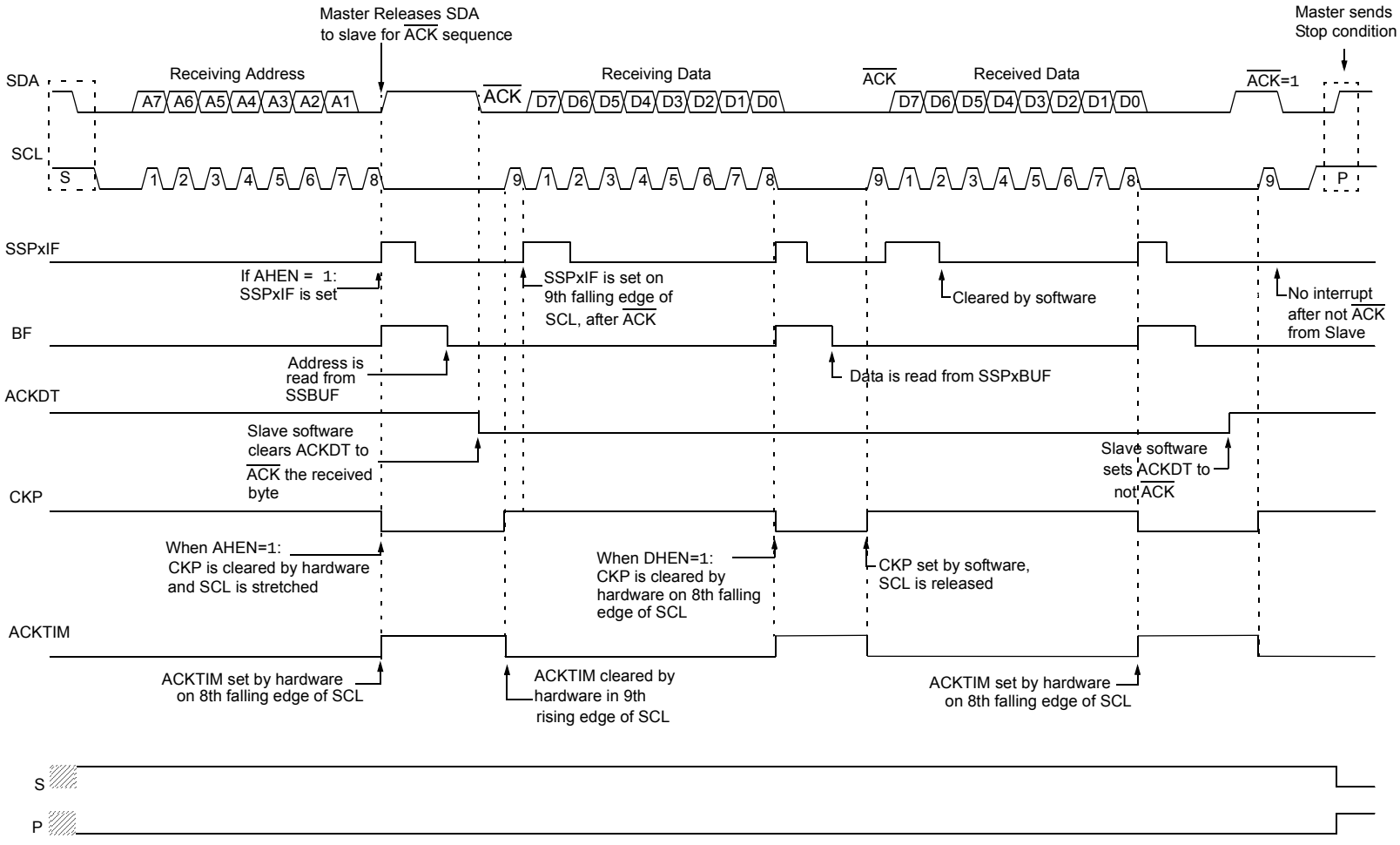


FIGURE 26-16: I²C SLAVE, 7-BIT ADDRESS, RECEPTION (SEN = 0, AHEN = 1, DHEN = 1)



31.1 ADC Configuration

When configuring and using the ADC the following functions must be considered:

- Port configuration
- Channel selection
- ADC voltage reference selection
- ADC conversion clock source
- Interrupt control
- Result formatting
- Conversion Trigger Selection
- ADC Acquisition Time
- ADC Precharge Time
- Additional Sample and Hold Capacitor
- Single/Double Sample Conversion
- Guard Ring Outputs

31.1.1 PORT CONFIGURATION

The ADC can be used to convert both analog and digital signals. When converting analog signals, the I/O pin should be configured for analog by setting the associated TRIS and ANSEL bits. Refer to **Section 15.0 "I/O Ports"** for more information.

Note:	Analog voltages on any pin that is defined as a digital input may cause the input buffer to conduct excess current.

31.1.2 CHANNEL SELECTION

There are several channel selections available:

- Eight PORTA pins (RA<7:0>)
- Eight PORTB pins (RB<7:0>)
- Eight PORTC pins (RC<7:0>)
- Temperature Indicator
- DAC output
- Fixed Voltage Reference (FVR)
- AVSS (ground)

The ADPCH register determines which channel is connected to the sample and hold circuit.

When changing channels, a delay is required before starting the next conversion. 0

Refer to **Section 31.2 "ADC Operation"** for more information.

Note:	It is recommended that when switching from an ADC channel of a higher voltage to a channel of a lower voltage, the software selects the VSS channel before switching. If the ADC does not have a dedicated VSS input channel, the VSS selection (DAC1R<4:0> = b'00000') through the DAC output channel can be used. If the DAC is in use, a free input channel can be connected to VSS, and can be used in place of the DAC.

31.1.3 ADC VOLTAGE REFERENCE

The ADPREF<1:0> bits of the ADREF register provide control of the positive voltage reference. The positive voltage reference can be:

- VREF+ pin
- VDD
- FVR 1.024V
- FVR 2.048V
- FVR 4.096V

The ADNREF bit of the ADREF register provides control of the negative voltage reference. The negative voltage reference can be:

- VREF- pin
- VSS

See **Section 28.0 "Fixed Voltage Reference (FVR)"** for more details on the Fixed Voltage Reference.

31.1.4 CONVERSION CLOCK

The source of the conversion clock is software selectable via the ADCLK register and the ADCS bits of the ADCON0 register. There are 66 possible clock options:

- FOSC/2
- FOSC/4
- FOSC/6
- FOSC/8
- FOSC/10

  .

  .

  .
- FOSC/128
- FRC (dedicated RC oscillator)

The time to complete one bit conversion is defined as TAD. One full 10-bit conversion requires 11.5 TAD periods as shown in Figure 31-2.

For correct conversion, the appropriate TAD specification must be met. Refer to Table 37-14 for more information. Table 31-1 gives examples of appropriate ADC clock selections.

Note 1:	Unless using the FRC, any changes in the system clock frequency will change the ADC clock frequency, which may adversely affect the ADC result.
2:	The internal control logic of the ADC runs off of the clock selected by the ADCS bit of ADCON0. What this can mean is when the ADCS bit of ADCON0 is set to '1' (ADC runs on FRC), there may be unexpected delays in operation when setting ADC control bits.

TABLE 32-3: SUMMARY OF REGISTERS ASSOCIATED WITH COMPARATOR MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
CMxCON0	EN	OUT	—	POL	—	—	HYS	SYNC	462
CMxCON1	—	—	—	—	—	—	CxINTP	CxINTN	463
CMxNCH	—	—	—	—	—	NCH<2:0>			463
CMxPCH	—	—	—	—	—	PCH<2:0>			464
CMOUT	—	—	—	—	—	—	MC2OUT	MC1OUT	464
FVRCON	FVREN	FVRRDY	TSEN	TSRNG	CDAFVR<1:0>		ADFVR<1:0>		417
INTCON	GIE/GIEH	PEIE/GIEL	IPEN	—	—	INT2EDG	INT1EDG	INT0EDG	166
PIR2	HLVDIF	ZCDIF	—	—	—	—	C2IF	C1IF	169
PIE2	HLVDIE	ZCDIE	—	—	—	—	C2IE	C1IE	177
IPR2	HLVDIP	ZCDIP	—	—	—	—	C2IP	C1IP	185
PMD2	—	DACMD	ADCMD	—	—	CMP2MD	CMP1MD	ZCDMD	66
RxyPPS	—	—	—	RxyPPS<4:0>					213

Legend: — = unimplemented, read as '0'. Shaded cells are unused by the comparator module.

ANDWF **AND W with f**

Syntax: ANDWF f {,d {,a}}

Operands: $0 \le f \le 255$
$d \in [0,1]$
$a \in [0,1]$

Operation: (W) .AND. (f) → dest

Status Affected: N, Z

Encoding:

0001	01da	ffff	ffff

Description: The contents of W are AND'ed with register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).
If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See **Section 35.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: `ANDWF REG, 0, 0`

Before Instruction
W = 17h
REG = C2h
After Instruction
W = 02h
REG = C2h

BC **Branch if Carry**

Syntax: BC n

Operands: $-128 \le n \le 127$

Operation: if CARRY bit is '1'
(PC) + 2 + 2n → PC

Status Affected: None

Encoding:

1110	0010	nnnn	nnnn

Description: If the CARRY bit is '1', then the program will branch.
The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a 2-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:
If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	No operation

Example:
```
HERE    BC   5
```
Before Instruction
PC = address (HERE)
After Instruction
If CARRY = 1;
PC = address (HERE + 12)
If CARRY = 0;
PC = address (HERE + 2)

36.11 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ® security ICs, CAN, IrDA®, PowerSmart battery management, SEEVAL® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

36.12 Third-Party Development Tools

Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent® and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika®